



Dual P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
- 20	0.015 at V _{GS} = - 4.5 V	- 9.4		
	0.019 at V _{GS} = - 2.5 V	- 8.4		
	0.024 at V _{GS} = - 1.8 V	- 7.5		

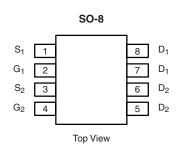
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- Compliant to RoHS Directive 2002/95/EC



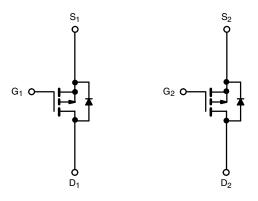
APPLICATIONS

· Load Switching



Ordering Information: Si4913DY-T1-E3 (Lead (Pb)-free)

Si4913DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

P-Channel MOSFET

Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	- 20		V
Gate-Source Voltage		V_{GS}	± 8		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	- I _D	- 9.4	- 7.1	^
	T _A = 70 °C		- 7.5	- 5.7	
Pulsed Drain Current		I _{DM}	- 30		Α
Continuous Source Current (Diode Conduction) ^a		I _S	- 1.7	- 0.9	
Maximum Power Dissipation ^a	T _A = 25 °C	- P _D	2.0	1.1	W
	T _A = 70 °C		1.3	0.7	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manipular to Aughtenta	t ≤ 10 s	- R _{thJA}	45	62.5		
Maximum Junction-to-Ambient ^a	Steady State		85	110	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	26	35		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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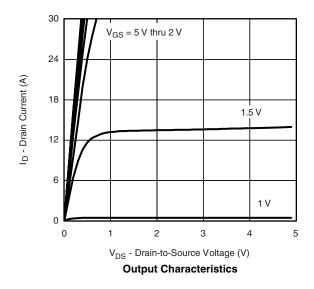
SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions Min. Typ.		Max.	Unit		
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -500 \mu\text{A}$ - 0.40			- 1.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V			- 1	μΑ	
		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 5		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 4.5 V	- 30			Α	
		$V_{GS} = -4.5 \text{ V}, I_D = -9.4 \text{ A}$		0.0125	0.015	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 8.4 A		0.0155	0.019		
		V _{GS} = - 1.8 V, I _D = - 3.0 A		0.020	0.024		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 9.4 A		40		S	
Diode Forward Voltage ^a	V_{SD}	$I_S = -1.7 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.7	- 1.2	V	
Dynamic ^b							
Total Gate Charge	Q_g			43	65		
Gate-Source Charge	Q_{gs}	Q_{gs} $V_{DS} = 10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -9.4 \text{ A}$		7.1		nC	
Gate-Drain Charge	Q_{gd}			10.9		1	
Turn-On Delay Time	t _{d(on)}			32	50		
Rise Time	t _r	V_{DD} = 10 V, R_L = 10 Ω		42	65		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 1 A, V_GEN = - 4.5 V, R_g = 6 Ω		350	525	ns	
Fall Time	t _f			160	240		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1.7 A, dl/dt = 100 A/μs		127	200		

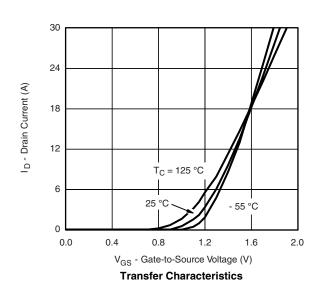
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

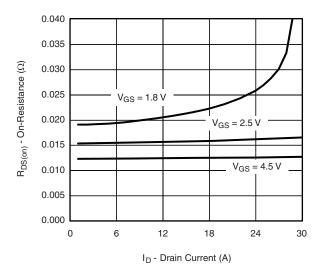




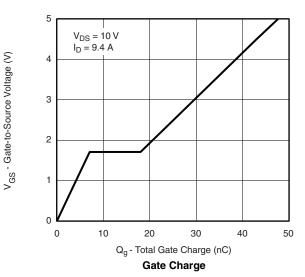


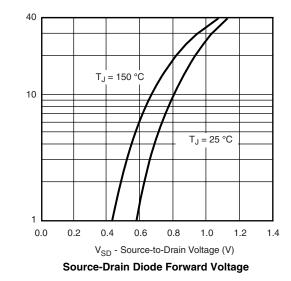


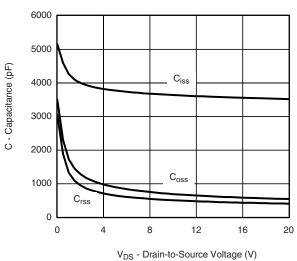
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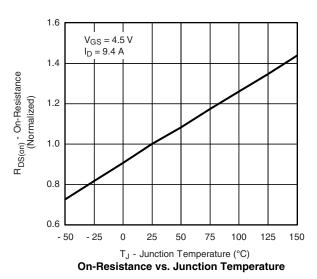
On-Resistance vs. Drain Current







Capacitance



0.040 0.035 0.030 0.025 0.025 0.020 0.015 0.010 0.005 0.000 0 1 2 3 4 5 V_{GS} - Gate-to-Source Voltage (V)

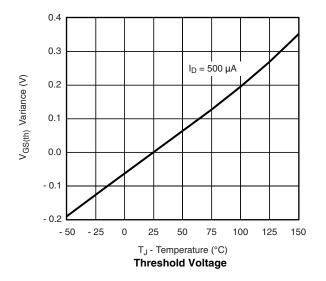
On-Resistance vs. Gate-to-Source Voltage

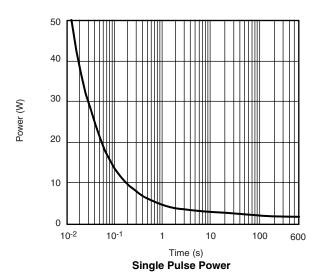
I_S - Source Current (A)

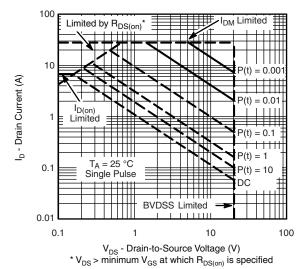
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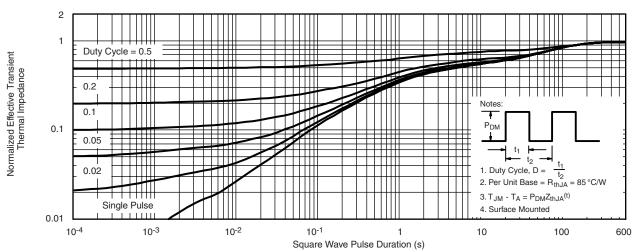
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







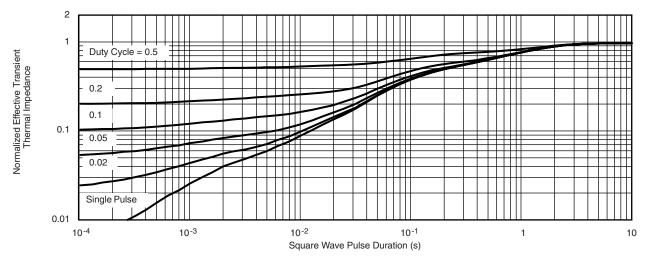
Safe Operating Area, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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